

PATENT ASSIGNMENT COVER SHEET

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| SUBMISSION TYPE: | NEW ASSIGNMENT | |
| NATURE OF CONVEYANCE: | ASSIGNMENT | |
| CONVEYING PARTY DATA | | |
| | Name | Execution Date |
| | KAI CHENG | 02/22/2021 |
| RECEIVING PARTY DATA | | |
| Name: | ENKRIS SEMICONDUCTOR, INC. | |
| Street Address: | ROOM517-A BUILDING NW-20, NO.99, JINJI LAKE AVENUE, SUZHOU INDUSTRIAL PARK | |
| City: | SUZHOU, JIANGSU | |
| State/Country: | CHINA | |
| Postal Code: | 215123 | |
| PROPERTY NUMBERS Total: 1 | | |
| Property Type | Number | |
| Application Number: | 17273295 | |
| CORRESPONDENCE DATA | | |
| Fax Number: | (971)271-8021 | |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> | | |
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| ATTORNEY DOCKET NUMBER: | KEW21304PCTUS | |
| NAME OF SUBMITTER: | OONA R. FISHER CAMPBELL | |
| SIGNATURE: | /Oona R. Fisher Campbell/ | |
| DATE SIGNED: | 03/04/2021 | |
| Total Attachments: 2 | | |
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| source=Assignment_KEW21304PCTUS#page2.tif | | |

ASSIGNMENT

WHEREAS, we, **Kai CHENG** have invented subject matter disclosed and/or claimed in a patent application entitled SEMICONDUCTOR STRUCTURES AND SUBSTRATES THEREOF, AND METHODS OF MANUFACTURING SEMICONDUCTOR STRUCTURES AND SUBSTRATES THEREOF, the specification of which:

☐ is attached hereto; or

☒ was filed on March 3, 2021 and has been given application No. 17/273,295

(I hereby authorize the attorneys/agents at McCoy Russell LLP, Customer Number 00757, to insert the filing date and application number of said application when known)

WHEREAS, **ENKRIS SEMICONDUCTOR, INC.**, a **Chinese** corporation, having its principal place of business at **Room517-A Building NW-20, NO.99, Jinji Lake Avenue, Suzhou Industrial Park, Suzhou, Jiangsu, 215123 China**; is desirous of acquiring an interest therein;

March 3, 2021

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which hereby are acknowledged, we, **Kai CHENG**, have sold, assigned, and transferred, and do hereby sell, assign, and transfer, to **ENKRIS SEMICONDUCTOR, INC.**, its successors and assigns, the full and exclusive right to the invention in the United States and its territorial possessions and in all foreign countries, and the entire right, title, and interest in and to any and all Letters Patent that may be granted therefor in the United States and its territorial possessions and in any and all foreign countries, and in and to any and all divisions, continuations, reissues, substitutions, and extensions thereof.

We hereby authorize and request the Patent Office officials in the United States and any and all foreign countries to issue any and all of said Letters Patent, when granted, to **ENKRIS SEMICONDUCTOR, INC.**, as the assignee of our entire right, title, and interest in and to the same, for the sole use of **ENKRIS SEMICONDUCTOR, INC.**, and its successors and assigns.

Further, we hereby covenant and agree to and with **ENKRIS SEMICONDUCTOR, INC.**, and its successors and assigns, at the time of execution and delivery of these presents, that we are the sole and lawful owner of the entire right, title, and interest in and to the invention and the above-identified patent application, and that the same are unencumbered, and that we have good and full right and lawful authority to sell and convey the same in the manner herein set forth.

Further, we agree that we will communicate to ENKRIS SEMICONDUCTOR, INC., or its representatives, any facts known to us respecting the invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue, substitution, and extension applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to ENKRIS SEMICONDUCTOR, INC., make all rightful oaths, and generally do everything possible to aid ENKRIS SEMICONDUCTOR, INC., and its successors and assigns, to obtain and enforce proper protection for the invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, I have hereunto set my hand this 22th day of February, 2021.


Kai CHENG

Witness:

Signature: Liangfang Sun

Name: Liangfang Sun

Address: Room 517-A Building NW-20, NO.99, Jinji Lake Avenue, Suzhou Industrial Park
Suzhou, Jiangsu, 215123 China

City & State: